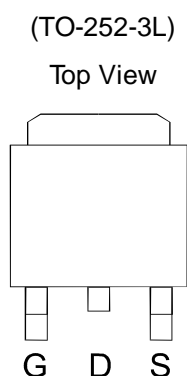


**P- Channel 30-V (D-S) MOSFET**

**GENERAL DESCRIPTION**

The ME20P03 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits , and low in-line power loss are needed in a very small outline surface mount package.

**PIN CONFIGURATION**

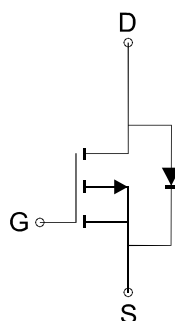


**FEATURES**

- $R_{DS(ON)} \leq 32m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} \leq 42m\Omega @ V_{GS} = -4.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

**APPLICATIONS**

- Power Management in Note book
- DC/DC Converter
- Load Switch
- LCD Display inverter



P-Channel MOSFET

Ordering Information: ME20P03 (Pb-free)  
ME20P03-G (Green product-Halogen free)

**Absolute Maximum Ratings (Tc=25°C Unless Otherwise Noted)**

| Parameter                            | Symbol          | Maximum Ratings | Unit  |
|--------------------------------------|-----------------|-----------------|-------|
| Drain-Source Voltage                 | $V_{DS}$        | -30             | V     |
| Gate-Source Voltage                  | $V_{GS}$        | $\pm 20$        | V     |
| Continuous Drain Current             | $I_D$           | Tc=25°C         | -27.6 |
|                                      |                 | Tc=70°C         | -25.5 |
| Pulsed Drain Current                 | $I_{DM}$        | -110            | A     |
| Maximum Power Dissipation            | $P_D$           | Tc=25°C         | 39    |
|                                      |                 | Tc=70°C         | 25    |
| Operating Junction Temperature       | $T_J$           | -55 to 150      | °C    |
| Thermal Resistance-Junction to Case* | $R_{\theta JC}$ | 3.2             | °C/W  |

\*The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper



**P- Channel 30-V (D-S) MOSFET**
**Electrical Characteristics** (T<sub>c</sub>=25°C Unless Otherwise Specified)

| Symbol               | Parameter                                     | Limit   | Min | Typ  | Max  | Unit |
|----------------------|---|---|-----|------|------|------|
| <b>STATIC</b>        |   |   |     |      |      |      |
| V <sub>(BR)DSS</sub> | Drain-Source Breakdown Voltage                | V <sub>GS</sub> =0V, I <sub>D</sub> =-250 μA  | -30 |      |      | V    |
| V <sub>GS(th)</sub>  | Gate Threshold Voltage                        | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250 μA  | -1  |      | -3   | V    |
| I <sub>GSS</sub>     | Gate Leakage Current                          | V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V  |     |      | ±100 | nA   |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current               | V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V  |     |      | -1   | μA   |
| R <sub>DS(ON)</sub>  | Drain-Source On-State Resistance <sup>a</sup> | V <sub>GS</sub> =-10V, I <sub>D</sub> = -18A  |     | 27   | 32   | mΩ   |
|                      |   | V <sub>GS</sub> =-4.5V, I <sub>D</sub> = -10A   |     | 35   | 42   |      |
| V <sub>SD</sub>      | Diode Forward Voltage                         | I <sub>S</sub> =-1A, V <sub>GS</sub> =0V  |     | -0.7 | -1.2 | V    |
| <b>DYNAMIC</b>       |   |   |     |      |      |      |
| Q <sub>g</sub>       | Total Gate Charge(10V)                        | V <sub>DS</sub> =-15V, V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-18A   |     | 21   |      | nC   |
| Q <sub>g</sub>       | Total Gate Charge(4.5V)                       |   |     | 10   |      |      |
| Q <sub>gs</sub>      | Gate-Source Charge                            |   |     | 5    |      |      |
| Q <sub>gd</sub>      | Gate-Drain Charge                             |   |     | 4.2  |      |      |
| C <sub>iss</sub>     | Input capacitance                             | V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V, F=1MHz  |     | 804  |      | pF   |
| C <sub>oss</sub>     | Output Capacitance                            |   |     | 123  |      |      |
| C <sub>rss</sub>     | Reverse Transfer Capacitance                  |   |     | 40   |      |      |
| t <sub>d(on)</sub>   | Turn-On Delay Time                            | V <sub>DS</sub> =-15V, R <sub>L</sub> =15Ω<br>I <sub>D</sub> =-1A, V <sub>GEN</sub> =-10V, R <sub>G</sub> =3Ω |     | 37   |      | ns   |
| t <sub>r</sub>       | Turn-On Rise Time                             |   |     | 19   |      |      |
| t <sub>d(off)</sub>  | Turn-Off Delay Time                           |   |     | 54   |      |      |
| t <sub>f</sub>       | Turn-Off Fall Time                            |   |     | 7    |      |      |

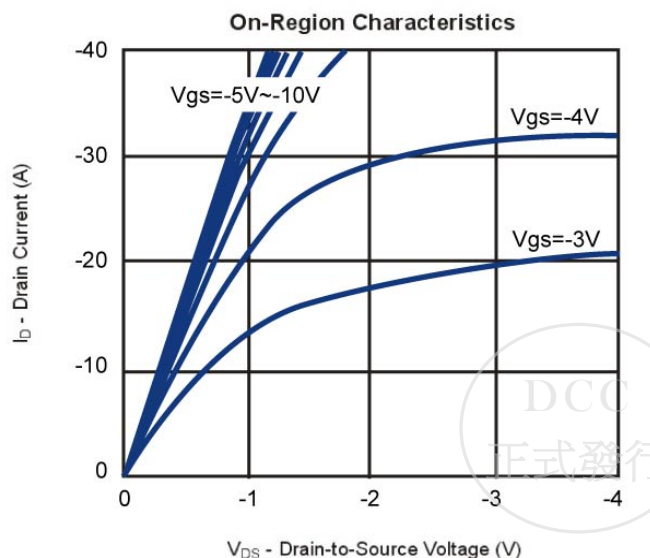
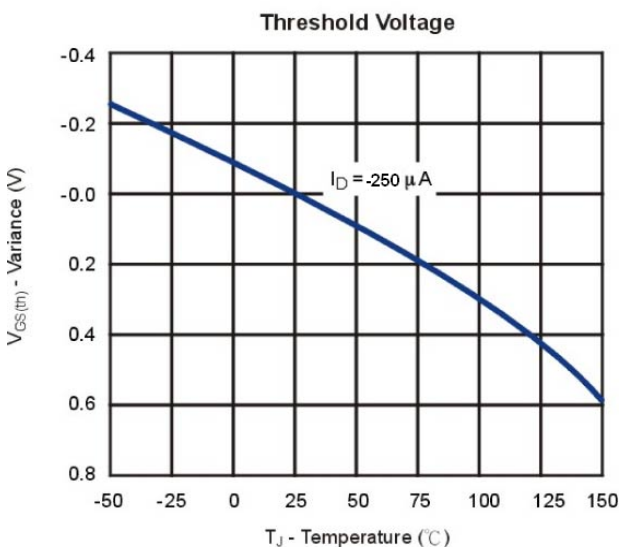
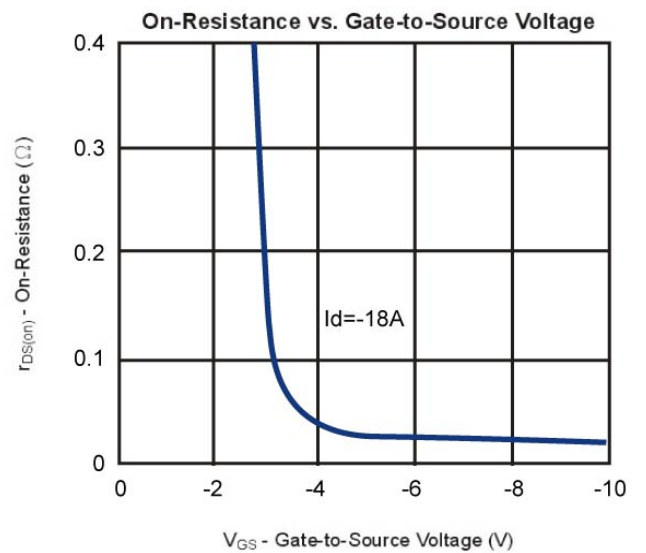
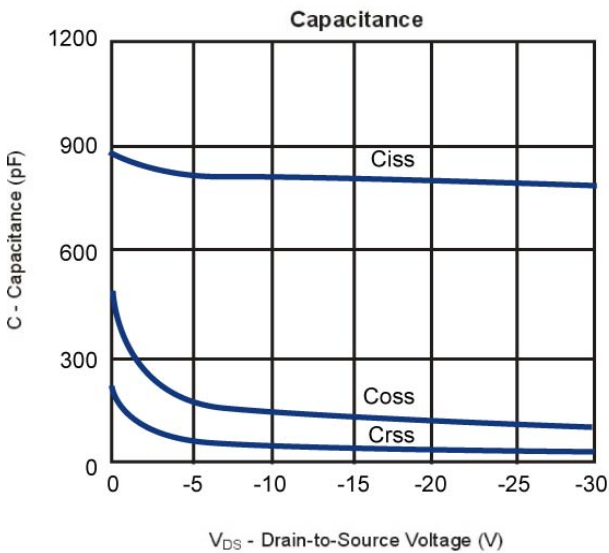
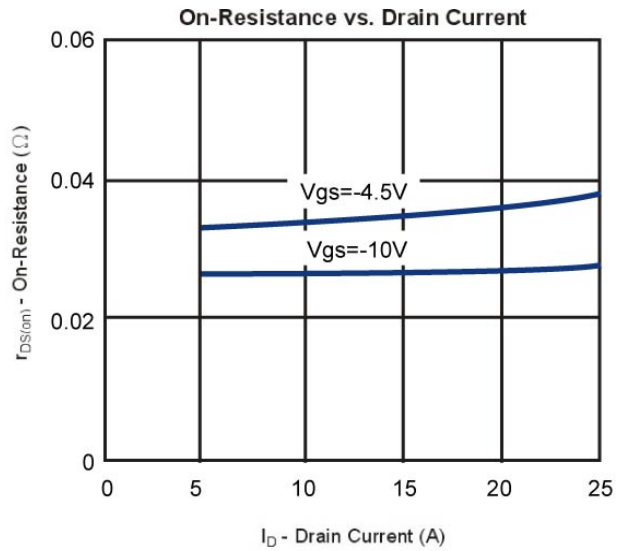
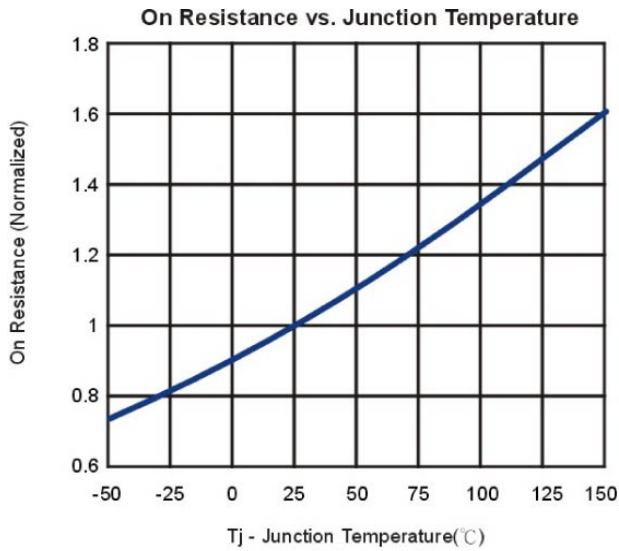
Notes:a. Pulse test; pulse width ≤ 300us, duty cycle ≤ 2%

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



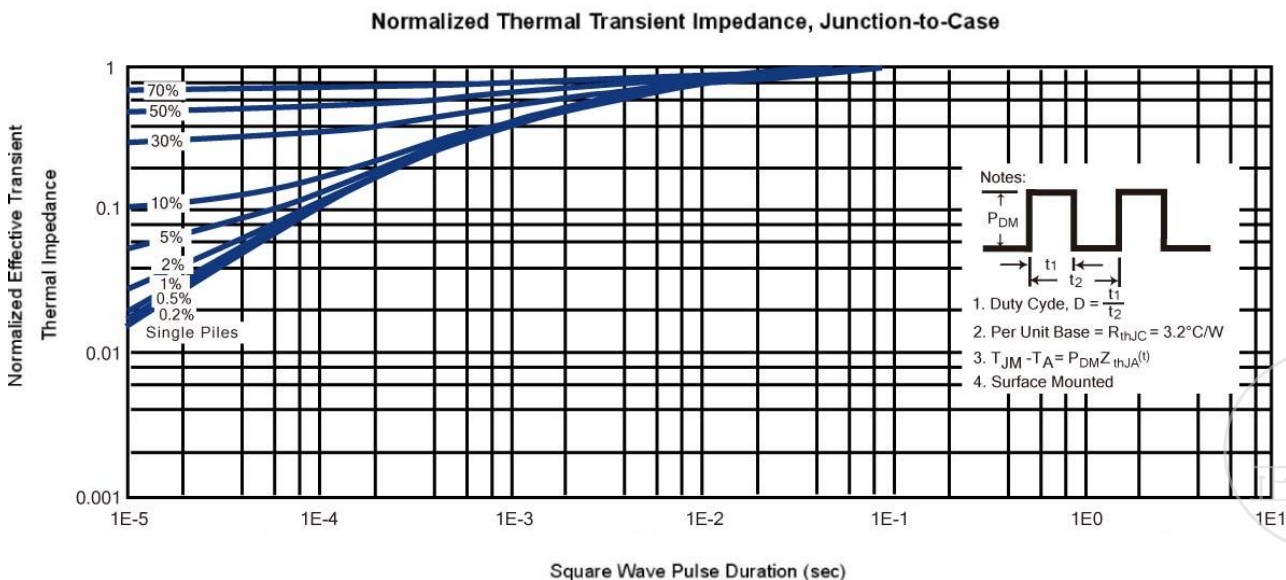
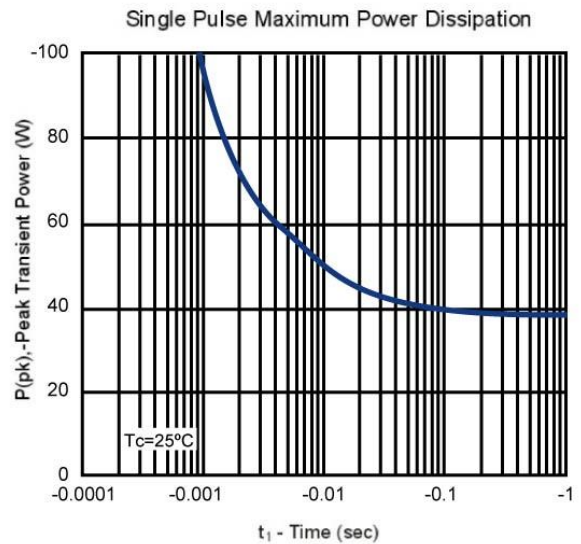
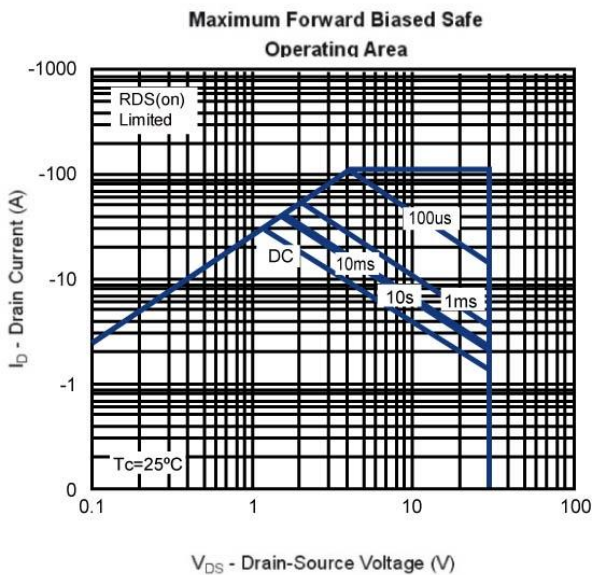
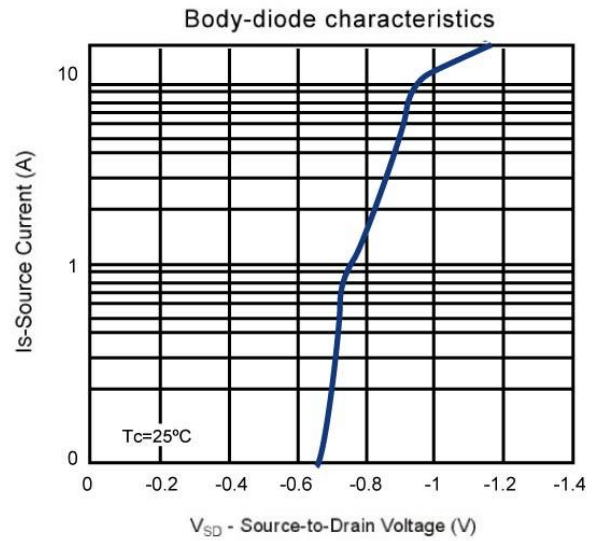
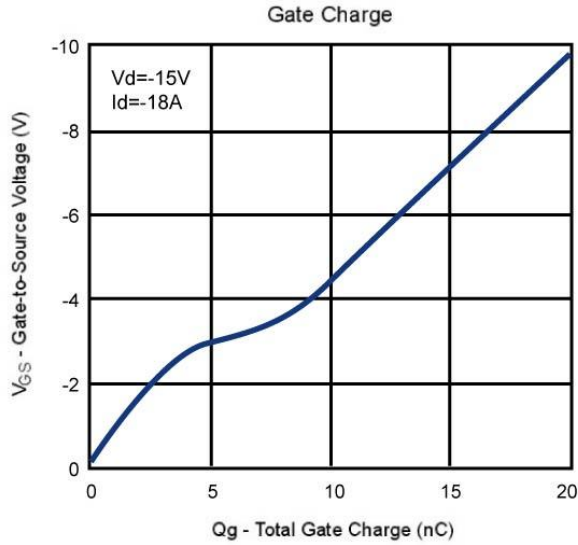
**P- Channel 30-V (D-S) MOSFET**

**Typical Characteristics (T<sub>J</sub> = 25°C Noted)**



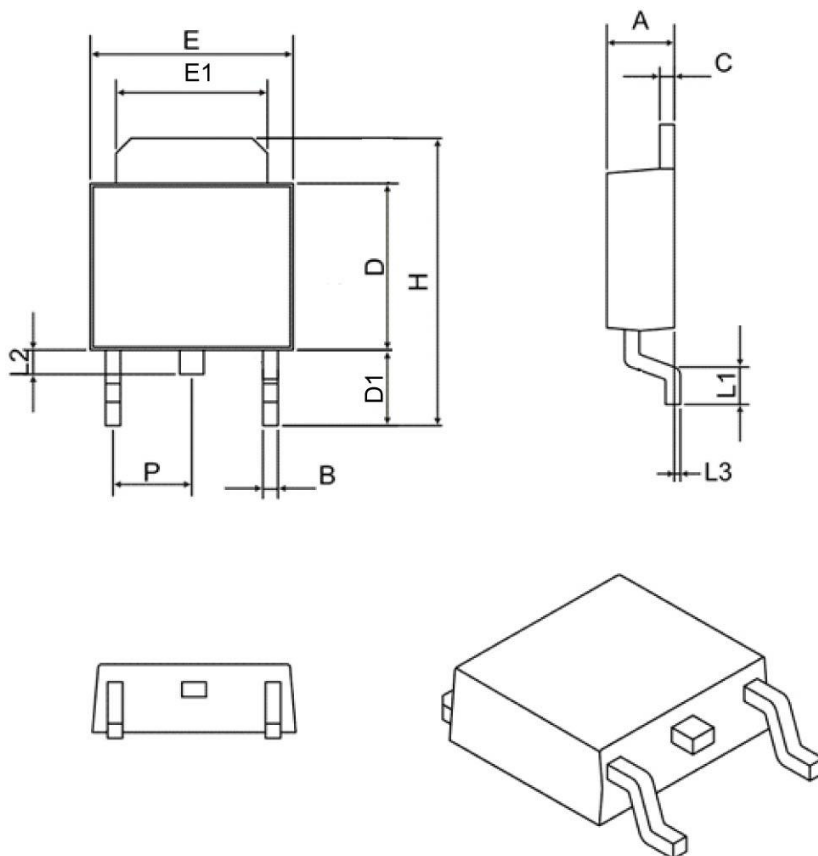
**P- Channel 30-V (D-S) MOSFET**

**Typical Characteristics (T<sub>J</sub> = 25°C Noted)**



DCC  
正式發行

## TO-252 Package Outline



| SYMBOL | MIN      | MAX   |
|--------|----------|-------|
| A      | 2.10     | 2.50  |
| B      | 0.40     | 0.90  |
| C      | 0.40     | 0.90  |
| D      | 5.30     | 6.30  |
| D1     | 2.20     | 2.90  |
| E      | 6.30     | 6.75  |
| E1     | 4.80     | 5.50  |
| L1     | 0.90     | 1.80  |
| L2     | 0.50     | 1.10  |
| L3     | 0.00     | 0.20  |
| H      | 8.90     | 10.40 |
| P      | 2.30 BSC |       |

